		Γ		week No.	4	9	15	21	27	39	43	48
				2024	22-Jan	26-Feb	08-Apr	20-May	01-Jul	23-Sep	21-Oct	25-Nov
				DAYS				,				
-STD-001	(includes working copy of book which remains in class)											
Courses:	Module 1 and one other	£	1,000	2	22-Jan		08-Apr		01-Jul	1	21-Oct	
	Module 1 and two others	£	1,250	3	22-Jan		08-Apr		01-Jul		21-Oct	
	Module 1 and three others	£	1,750	4	22-Jan		08-Apr		01-Jul		21-Oct	
	Module 1 and all four others	£	2,000	5	22-Jan		08-Apr		01-Jul		21-Oct	
/lodules:												
	General requirements with open- book test: no workmanship											
	Wire preparation & terminals with open-book test; workmanship											
1	Through-hole PCB with open-book test; workmanship											
	Surface-mount PCB with open-book test; workmanship											
	Inspection & Process control with open-book test; no workmanship											
	ludes working copy of book which remains in class)											
Courses:	Modules 1, 2 and one other	£	1,000	2		26-Feb				23-Sep		
	Modules 1, 2 and up to seven others	£	1,250	3				20-May				25-Nov
										<u> </u>	<u> </u>	
Iodules:										<u> </u>	<u> </u>	
1	Introduction, Policies and Procedures									<u> </u>	<u> </u>	
2	Foreword, Applicable documents & Handling									<u> </u>	<u> </u>	
3	Hardware Installation									<u> </u>	\vdash	
4	Soldering (inc. high voltage)									<u> </u>	\vdash	
5	Terminal connections (also requires Modules 4 & 8)									<u> </u>	\vdash	
6	Through-hole technology (inc. jumper wires); (also requires Mod 4 & 8)									<u> </u>	───┘	
	Surface-mount assemblies (inc. jumper wires); (also requires Mod 4 & 8)									<u> </u>	┢───┘	
8	Component damage, PCB's and assemblies									<u> </u>	┢───┘	
9	Solderless Wire Wrap									<u> </u>	───′	
A 620 (inc	ludes working copy of book which remains in class)									<u> </u>	<u> </u>	
Courses:	Module 1 and one other	f	1,000	2				23-May			┝───┦	28-No\
Jourses.	Module 1 and up to seven others	£	1,250	3		28-Feb		23-iviay		25-Sep	┝───┦	20-1101
	indule - and up to seven others	L.	1,200	5		20-1 60				20-06p	+	
Modulae.										<u> </u>		
Iodules:	IPC Professional Policies and Procedures											
lodules: 1	IPC Professional Policies and Procedures											
lodules: 1	Foreword (Section 1)											
lodules: 1	Foreword (Section 1) Cable/Wire Preparation (Section 3)											
lodules: 1	Foreword (Section 1) Cable/Wire Preparation (Section 3) Measuring Cable Assemblies and Wires (Section 11)											
1	Foreword (Section 1) Cable/Wire Preparation (Section 3) Measuring Cable Assemblies and Wires (Section 11) Testing Cable Assemblies (Section 19)											
lodules: 1 2	Foreword (Section 1) Cable/Wire Preparation (Section 3) Measuring Cable Assemblies and Wires (Section 11) Testing Cable Assemblies (Section 19) Crimp Terminations (Section 5)											
1	Foreword (Section 1) Cable/Wire Preparation (Section 3) Measuring Cable Assemblies and Wires (Section 11) Testing Cable Assemblies (Section 19) Crimp Terminations (Section 5) Insulation Displacement Connections (IDC) (Section 6)											
1	Foreword (Section 1) Cable/Wire Preparation (Section 3) Measuring Cable Assemblies and Wires (Section 11) Testing Cable Assemblies (Section 19) Crimp Terminations (Section 5) Insulation Displacement Connections (IDC) (Section 6) Soldered Terminations (Section 4)											
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